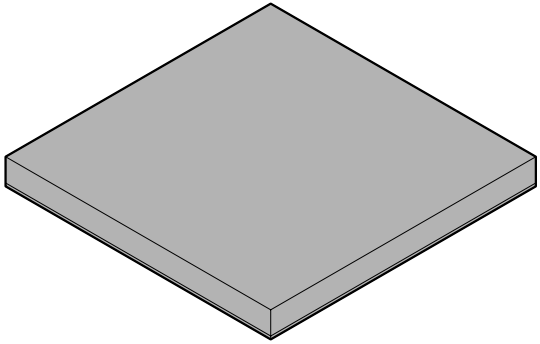
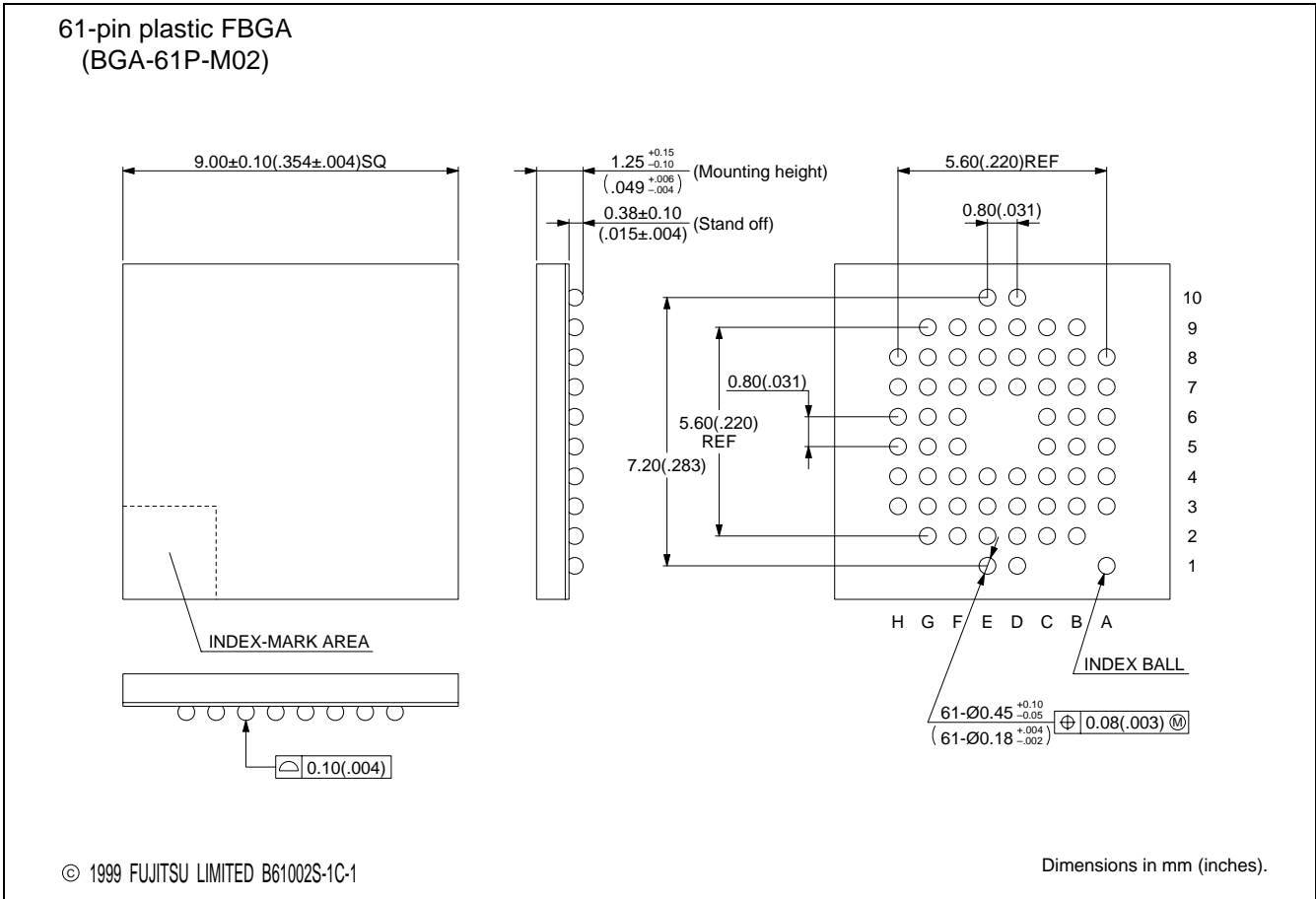


BGA-61P-M02

<p>61-pin plastic FBGA</p>  <p>(BGA-61P-M02)</p>	Ball pitch	0.80 mm (Pin pitch)	
	Package width × package length	9.0 × 9.0 mm	
	Sealing method	Plastic mold	
	Mounting height	1.40 mm MAX	
	Weight	About 0.16 g	



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